F. Silicon and Group-IV Devices and Integration Technology 분과 [TB2-F] New Applications of Silicon Technology

TB2-F-1 10:45~11:15	[초청] New Generation of SOI Substrate Solutions for RF and Millimeter-wave Applications Jean-Pierre Raskin <i>Université catholique de Louvain</i>
TB2-F-2 11:15~11:45	[초청] Challenges and Opportunities in Memristor-based Artificial Neural Network (ANN) Hardware Shinhyun Choi <i>KAIST</i>
TB2-F-3 11:45~12:00	Schottky Diode in 45-nm Embedded Flash Process for Power Management System YongSeok Chung, ChangHyun Park, Changmin Jeon, Youngho Kim, Sangjin Lee, Yong Kyu Lee, Kichul Park, and Gitae Jeong Foundry Business, Samsung Electronics Co., Ltd.
TB2-F-4 12:00~12:15	Ternary CMOS Technology based on 28-nm Foundry Process Jae Won Jeong, Young Eun Choi, Woo-Seok Kim, and Kyung Rok Kim <i>School of Electrical and Computer Engineering, UNIST</i>
TB2-F-5 12:15~12:30	Proposal and Simulation of a Low Loss, Highly Efficient Monolithic III-V/Si Optical Phase Shifter SangHyeon Kim ^{1,2} , Younghyun Kim ² , Yoojin Ban ² , Pantouvaki Marianna ² , and Joris Van Campenhout ² ¹ School of Electrical Engineering, KAIST, ²³ D&Optical I/O, IMEC